

**MICROPHONE
19B801499P1 & P2****SPECIFICATIONS:**

STANDARD	METHODS/PROCEDURES	
	MIL-810-C	MIL-810-D
Humidity	Procedure 514.3, Curve W	Procedure 507.2
Temperature		Procedure 501.2/502.2/503.2
Vibration		
Weatherproof (Driven Rain)		Procedure 506.2
Corrosion		Procedure 509.2
Dust		Procedure 516.3

Weight: 220 grams (7-3/4 oz) without cord

Connector: 6 pin Delta style (P1)
9pin D-connector subminiature (P2)

Impedance: 600 ohms

Frequency Response: 300-5000 Hz

Audio Output: 20-70 mV at 1000 Hz

**GE Mobile Communications**

General Electric Company
Lynchburg, Virginia 24502

Printed in U.S.A.

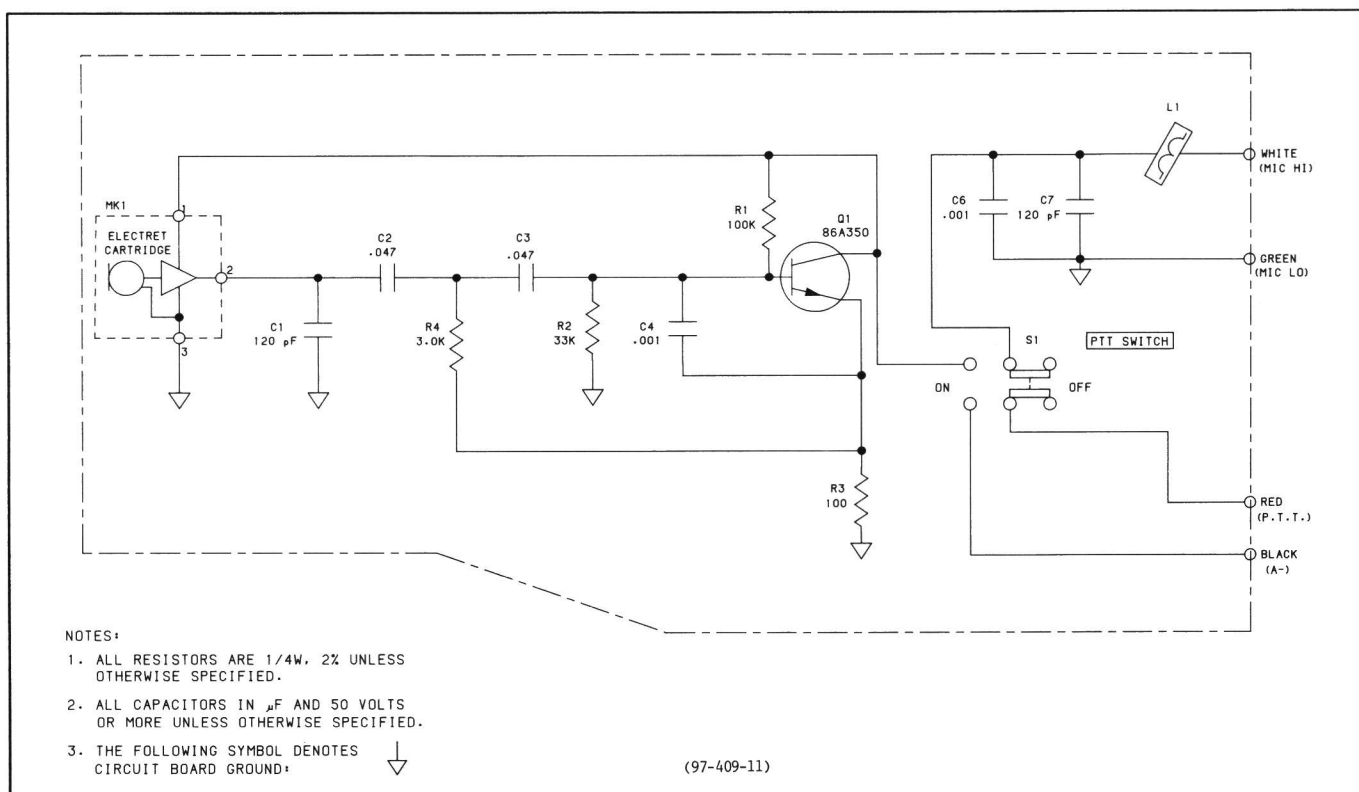


FIGURE 1 - SCHEMATIC DIAGRAM

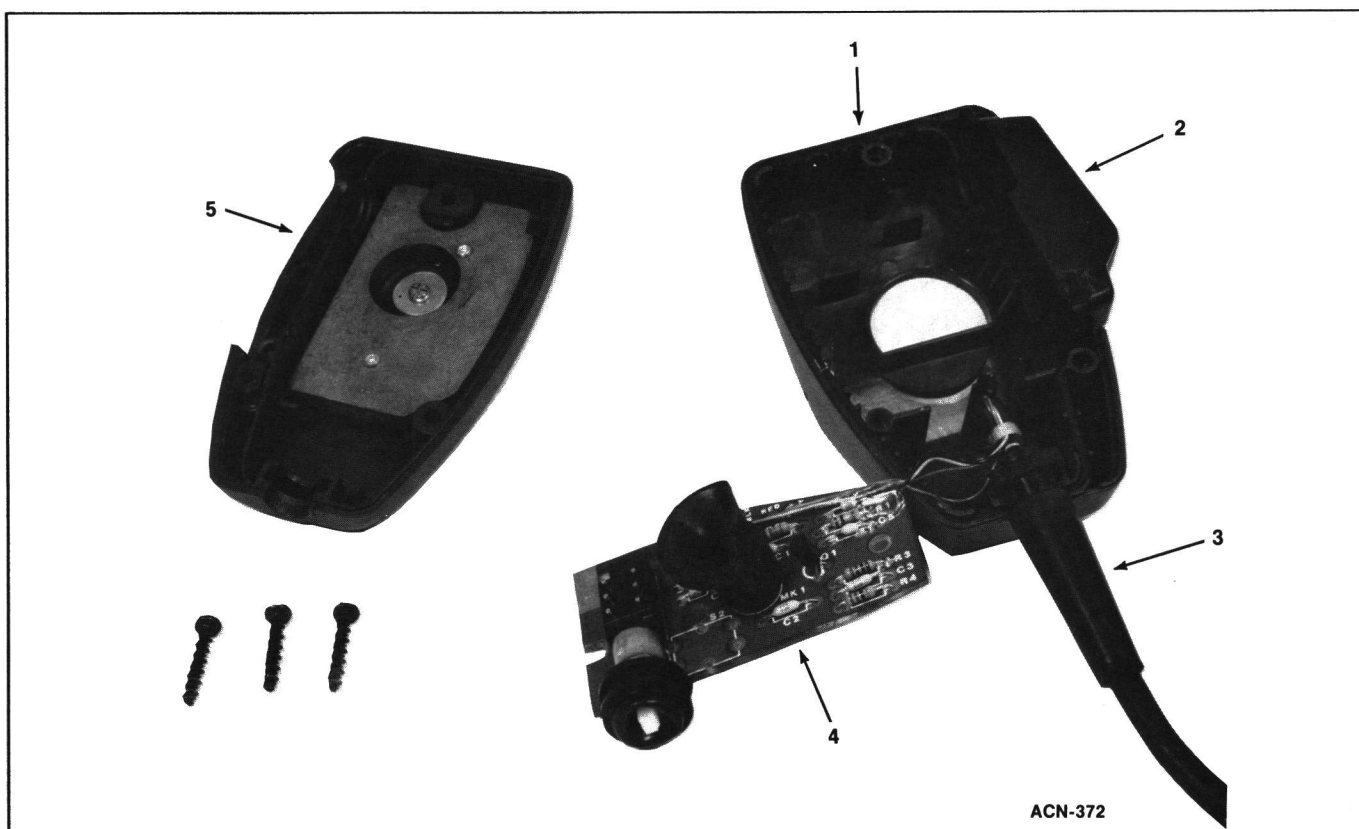


FIGURE 2 - DISASSEMBLED VIEW

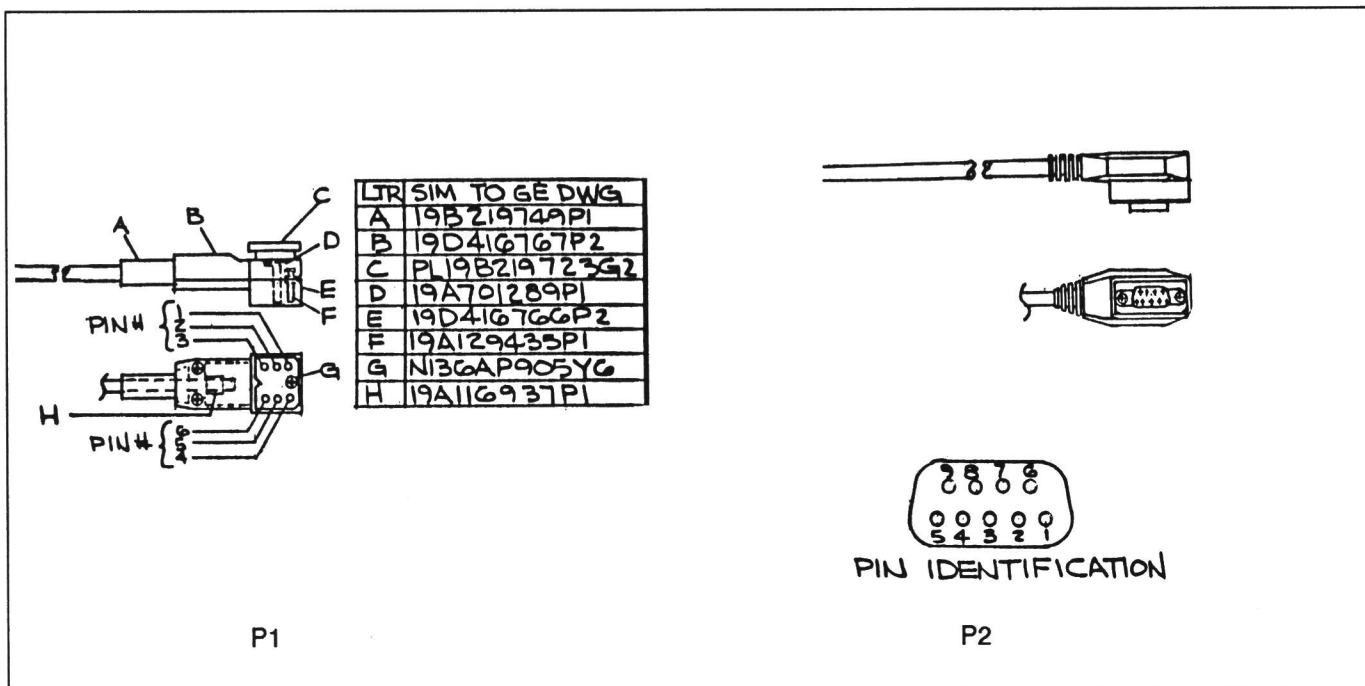


FIGURE 3 - CONNECTOR OUTLINE

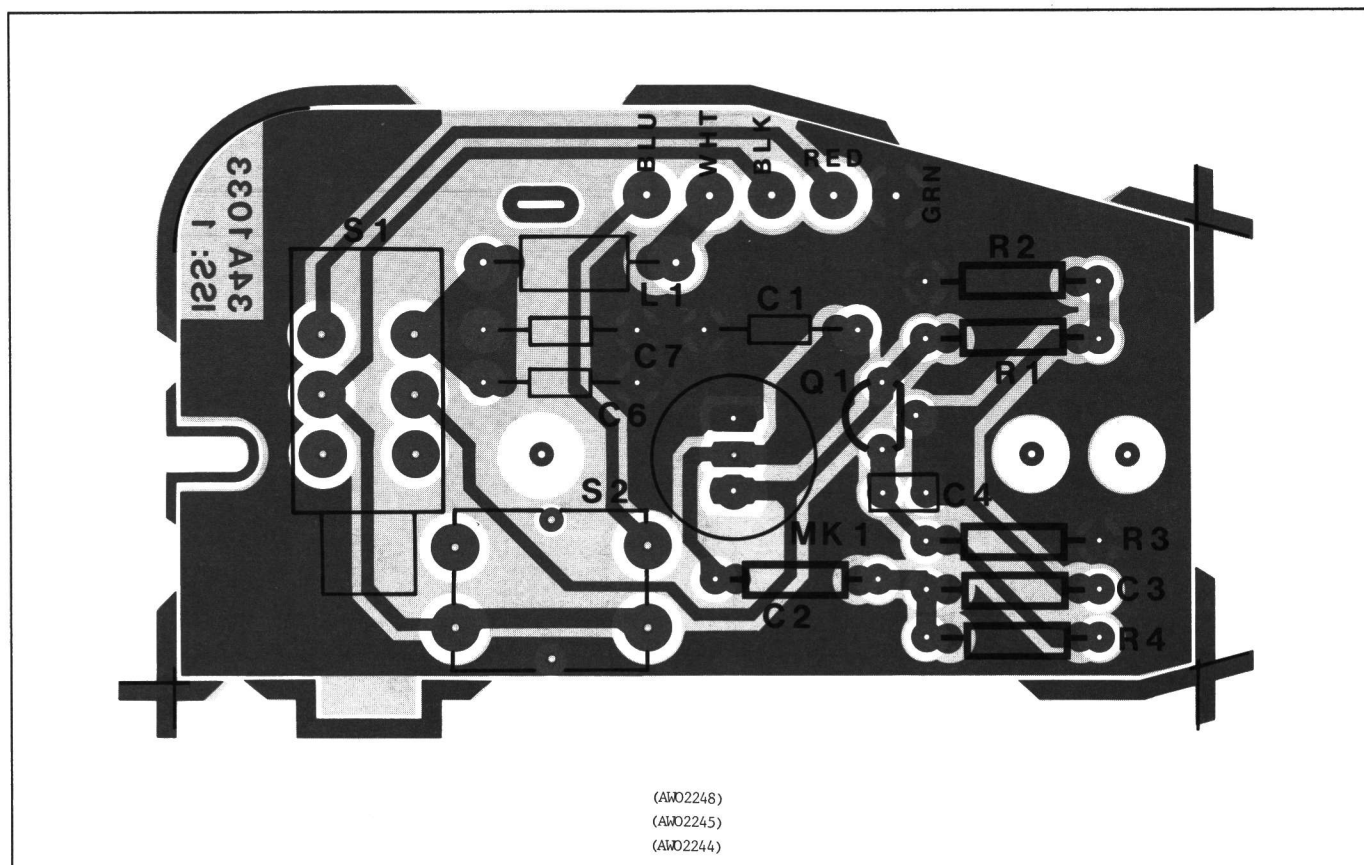


FIGURE 4 - PRINTED CIRCUIT BOARD ASSEMBLY

PARTS LIST

MICROPHONE
19B801499P1,P2
(Refer to Figure 2)

SYMBOL	PART NO.	DESCRIPTION
1	RP1004	Front Case Assembly.
2	RP1005	Switch Button.
3	19B801499P6	Cable assembly with MASTR II connector (P1 only).
	19B801499P7	Cable assembly with mini connector (P2 only).
4	RP1001	Printed Circuit Board Assembly with switch and microphone.
5	RP1003	Back Case Assembly.
		Screw, 1-inch Hi-Lo Phillips head, self-threading (Quantity 3).